

MOS FIELD EFFECT TRANSISTOR 2SK3322

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3322 is N-Channel DMOS FET device that features a low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply, AC adapter.

ORDERING INFORMATION

	PART NUMBER	PACKAGE TO-220AB (MP-25)		
	2SK3322			
	2SK3322-S	TO-262		
	2SK3322-ZJ	TO-263(MP-25ZJ)		
★	2SK3322-ZK	TO-263(MP-25ZK)		

FEATURES

★ • Low gate charge :

 $Q_G = 15 \text{ nC TYP}$. (VDD = 450 V, VGS = 10 V, ID = 5.5 A)

- Gate voltage rating : $\pm 30 \text{ V}$
- Low on-state resistance :

 $R_{\text{DS(on)}}$ = 2.2 Ω MAX. (VGs = 10 V, ID = 2.8 A)

- Avalanche capability ratings
- Surface mount package available

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	600	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±30	V
Drain Current (DC) (Tc = 25°C)	D(DC)	±5.5	А
Drain Current (pulse) ^{Note1}	D(pulse)	±20	А
Total Power Dissipation (T _A = 25°C)	P T1	1.5	W
Total Power Dissipation (Tc = 25°C)	P T2	65	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	4.0	А
Single Avalanche Energy Note2	Eas	10.7	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = 150 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

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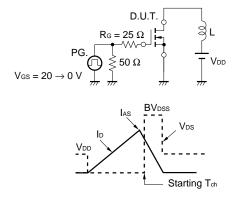
★ ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ibss	Vds = 600 V, Vgs = 0 V			100	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	2.5		3.5	V
Forward Transfer Admittance Note	y _{fs}	VDS = 10 V, ID = 2.8 A	1.0			S
Drain to Source On-state Resistance Note	RDS(on)	Vgs = 10 V, Id = 2.8 A		1.7	2.2	Ω
Input Capacitance	Ciss	Vds = 10 V,		550		pF
Output Capacitance	Coss	Vgs = 0 V,		115		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		13		pF
Turn-on Delay Time	t d(on)	$V_{DD} = 150 \text{ V}, \text{ Id} = 2.8 \text{ A},$		12		Ns
Rise Time	tr	Vgs = 10 V,		10		ns
Turn-off Delay Time	td(off)	Rg = 10 Ω		35		ns
Fall Time	tr			12		ns
Total Gate Charge	QG	Vdd = 450 V,		15		nC
Gate to Source Charge	Q _{GS}	Vgs = 10 V,		4		nC
Gate to Drain Charge	Qgd	I⊳ = 5.5 A		4.4		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 5.5 A, VGs = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 5.5 A, VGs = 0 V,		1.6		μs
Reverse Recovery Charge	Qrr	di/dt = 50 A/ μ s		5.3		μC

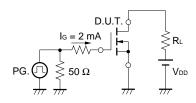
Note Pulsed

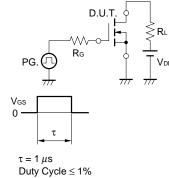
TEST CIRCUIT 1 AVALANCHE CAPABILITY

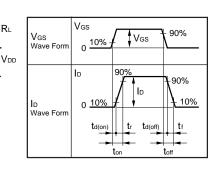
TEST CIRCUIT 2 SWITCHING TIME



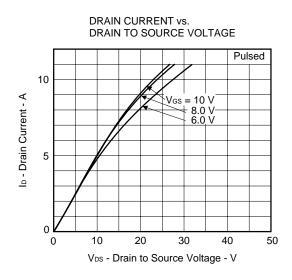
TEST CIRCUIT 3 GATE CHARGE

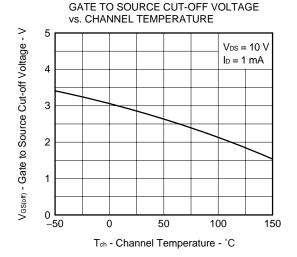


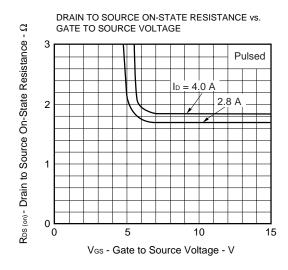




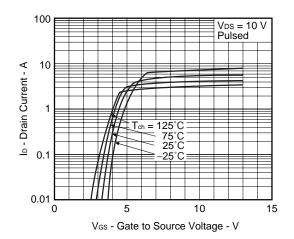
TYPICAL CHARACTERISTICS (TA = 25°C)



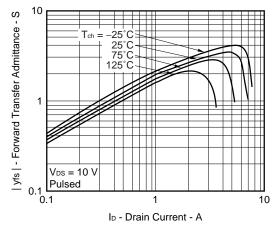


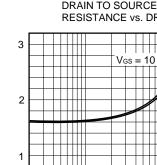


FORWARD TRANSFER CHARACTERISTICS

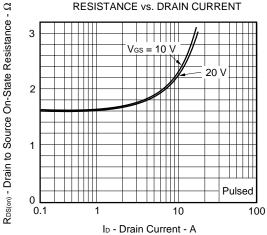


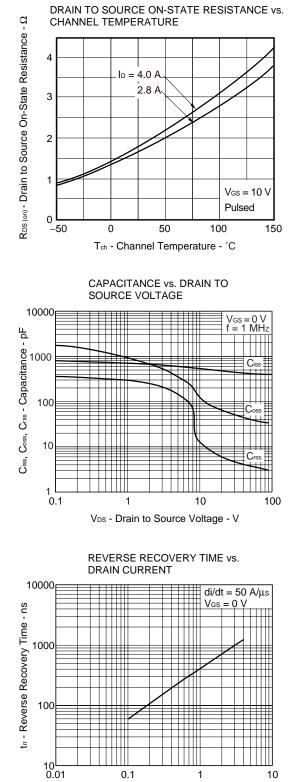
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



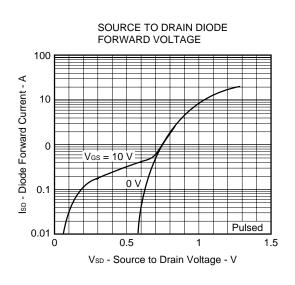


DRAIN TO SOURCE ON-STATE **RESISTANCE vs. DRAIN CURRENT**

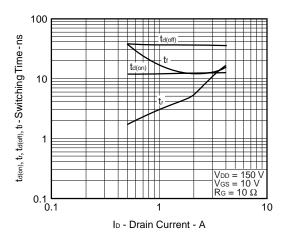




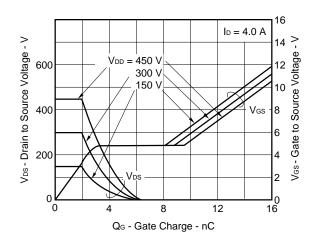
ID - Drain Current - A



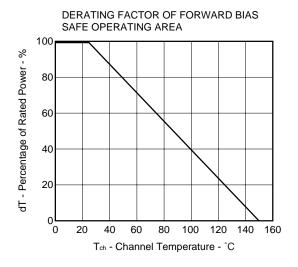
SWITCHING CHARACTERISTICS



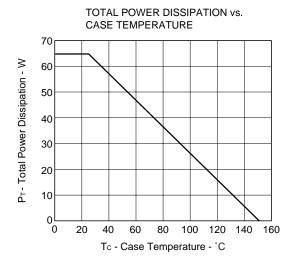




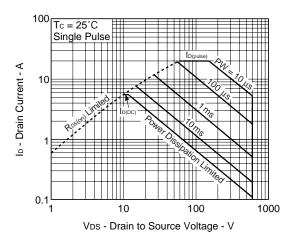
NEC

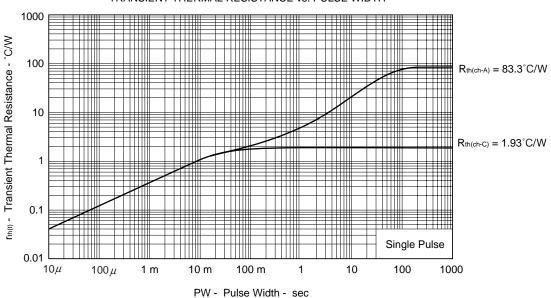


NEC



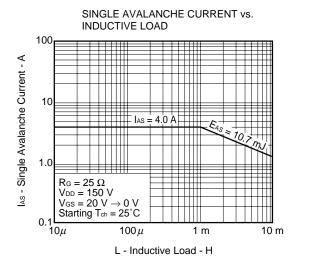
FORWARD BIAS SAFE OPERATING AREA

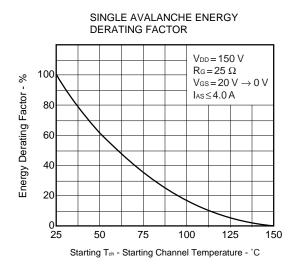




TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

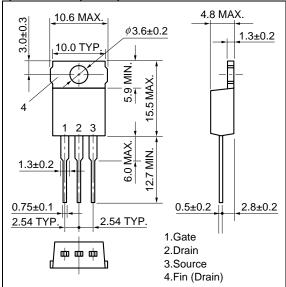




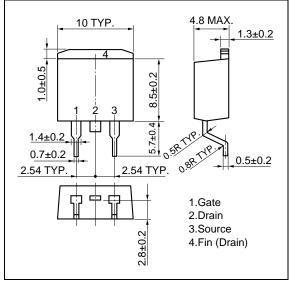


★ PACKAGE DRAWINGS (Unit: mm)

1) TO-220AB (MP-25)

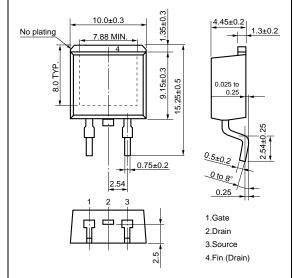


3) TO-263 (MP-25ZJ)

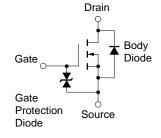


2) TO-262 ŝ 4.8 MAX. 040. 10 TYP 1.3±0.2 F 8.5±0.2 4 2 3 MIN 1.3±0.2 2.7 2.8±0.2 0.75±0.3 2.54 TYP 0.5±0.2 2.54 TYP. 1.Gate ф ф ф 2.Drain 3.Source 4.Fin (Drain)

4) TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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